Unit: mm

(3.2)

2.0±0.1

0.6±0.2

Base Collector 3: Emitter EIAJ: SC-92 TOP-3F-A1 Package

5.0±0.2

φ **3.2**±0.1

0±0.2

**1**±0.1

15.0±0.3

11.0±0.2

5

Ö

21.0±0.5

# **2SB1156**

## Silicon PNP epitaxial planar type

For power switching

Complementary to 2SD1707

#### Features

- Low collector-emitter saturation voltage  $V_{CE(sat)}$
- Satisfactory linearity of forward current transfer ratio h<sub>FE</sub>
- Large collector current  $I_C$

<ul> <li>Full-pack package which can be installed to the heat sink with one screw</li> <li>Absolute Maximum Ratings T<sub>C</sub> = 25°C</li> </ul>								
Parameter	Symbol	Rating	Unit	5.45				
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	-130	V	10.9±0.5				
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	-80	V	1 2 3				
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	-7	V					
Collector current	I <sub>C</sub>	-20	A	k.				
Peak collector current	I <sub>CP</sub>	-30	A					
Collector power dissipation	Pc	100	W	S.				
$T_a = 25^{\circ}C$		3		ate of				
Junction temperature	Tj	150	°C	the clear				
Storage temperature	T <sub>stg</sub>	-55 to +150	°C	pout latest				

### Electrical Characteristics $T_C = 25^{\circ}C \pm 3^{\circ}C$

Electrical Characteristics $T_c = 25^{\circ}C \pm 3^{\circ}C$									
Parameter	Symbol	Conditions	Min	Тур	Max	Unit			
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_{\rm C} = -10 \text{ mA}, I_{\rm B} = 0$	-80			V			
Collector-base cutoff current (Emitter open)	I <sub>CBO</sub>	$V_{\rm CB} = -100$ V, $I_{\rm E} = 0$			-10	μΑ			
Emitter-base cutoff current (Collector open)	I <sub>EBO</sub>	$V_{EB} = -5V, I_C = 0$			-50	μΑ			
Forward current transfer ratio	h <sub>FE1</sub>	$V_{CE} = -2 V_{TO} = -0.1 A$	45						
	h <sub>FE2</sub> *	$V_{CE} = -2 V, I_C = -3 A$	60		260				
	h <sub>FE3</sub>	$V_{CE} = -2 V, I_C = -10 A$	30						
Collector-emitter saturation voltage	VCE(sat)1	$I_C = -8 A, I_B = -0.4 A$			- 0.5	V			
	W <sub>CE(sat)2</sub>	$I_{\rm C} = -20$ A, $I_{\rm B} = -2$ A			-1.5				
Base-emitter saturation voltage	V <sub>BE(sat)1</sub>	$I_C = -8 A, I_B = -0.4 A$			-1.5	V			
*	V <sub>BE(sat)2</sub>	$I_{\rm C} = -20$ A, $I_{\rm B} = -2$ A			-2.5				
Transition frequency	f <sub>T</sub>	$V_{CE} = -10 \text{ V}, I_C = -0.5 \text{ A}, f = 10 \text{ MHz}$		30		MHz			
Turn-on time	t <sub>on</sub>	$I_{C} = -8 \text{ A}, I_{B1} = -0.8 \text{ A}, I_{B2} = 0.8 \text{ A}$		0.5		μs			
Storage time	t <sub>stg</sub>	$V_{CC} = -50 \text{ V}$		1.0		μs			
Fall time	t <sub>f</sub>			0.2		μs			

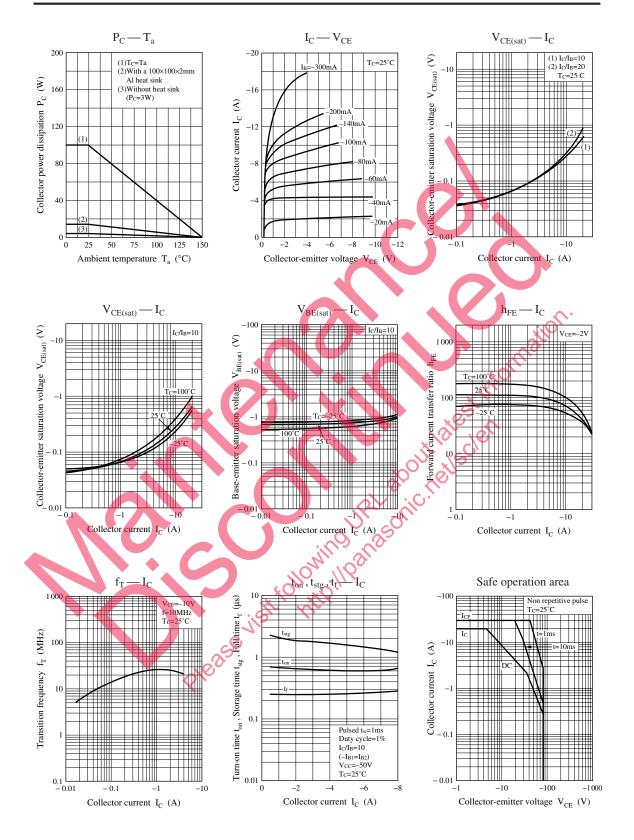
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. \*: Rank classification

Rank	R	Q	Р	
h <sub>FE2</sub>	60 to 120	90 to 180	130 to 260	

Ordering can be made by the common rank (PQ rank  $h_{FE2} = 60$  to 240) in the rank classification.

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